

## SNx4LVC00A クワッド、2 入力、正論理 NAND ゲート

### 1 特長

- JESD 22 を上回る ESD 保護
  - 2000V 人体モデル
  - 1000V 荷電デバイス モデル
- SN74LVC00A 動作範囲 1.65V ~ 3.6V
- SN54LVC00A 動作範囲 2V ~ 3.6V
- SNx4LVC00A  $-40^{\circ}\text{C} \sim +85^{\circ}\text{C}$  および  $-40^{\circ}\text{C} \sim +125^{\circ}\text{C}$  で動作を規定
- SN54LVC00A  $-55^{\circ}\text{C} \sim +125^{\circ}\text{C}$  で動作を規定
- 5.5V までの入力電圧に対応
- 最大  $t_{pd}$  4.3ns (3.3V 時)
- $V_{OLP}$  標準値 (出力グランド バウンス)  $< 0.8\text{V}$  ( $V_{CC} = 3.3\text{V}$ ,  $T_A = 25^{\circ}\text{C}$ )
- $V_{OHV}$  標準値 (出力  $V_{OH}$  アンダーシュート)  $> 2\text{V}$  ( $V_{CC} = 3.3\text{V}$ ,  $T_A = 25^{\circ}\text{C}$ )
- JESD 17 準拠  
250mA 超のラッチアップ性能
- MIL-PRF-38535 準拠の製品については、特に記述のない限り、すべてのパラメータはテスト済みです。その他のすべての製品については、量産プロセスにすべてのパラメータのテストが含まれているとは限りません。

### 2 アプリケーション

- AV レシーバ
- オーディオ ドック: ポータブル
- Blu-ray プレーヤおよびホーム シアター
- MP3 プレーヤ / レコーダ
- パーソナル デジタル アシスタント (PDA)
- 電源: テレコム / サーバ AC/DC 電源: シングルコントローラ: アナログおよびデジタル
- ソリッド ステート ドライブ (SSD): クライアントおよびエンタープライズ
- テレビ: LCD、デジタル、高解像度 (HDTV)
- タブレット: エンタープライズ
- ビデオ分析: サーバ
- ワイヤレス ヘッドセット、キーボード、マウス

### 3 概要

SN54LVC00A クワッド 2 入力正論理 NAND ゲートは 2.7V ~ 3.6V の  $V_{CC}$  で動作するように設計されており、SN74LVC00A クワッド 2 入力正論理 NAND ゲートは 1.65V ~ 3.6V の  $V_{CC}$  で動作するように設計されています。

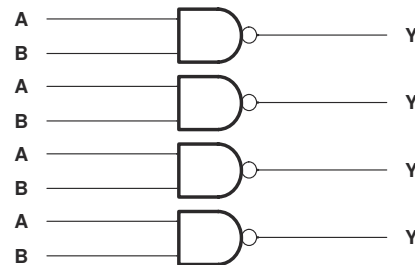
SNx4LVC00A デバイスは、ブール関数  $Y = \overline{A \cdot B}$ 、すなわち  $Y = \overline{A + B}$  を正論理で実行します。

入力は 3.3V または 5V のデバイスから駆動できます。この機能により、3.3V と 5V が混在するシステム環境での変換装置としてこのデバイスを使用できます。

#### 製品情報

| 部品番号        | パッケージ (1)      | パッケージ サイズ (2)   | 本体サイズ (3)          |
|-------------|----------------|-----------------|--------------------|
| SNx4LVC00A  | BQA (WQFN, 14) | 3mm × 2.5mm     | 3mm × 2.5mm        |
|             | D (SOIC, 14)   | 8.65mm × 6mm    | 8.65 mm × 3.91 mm  |
|             | DB (SSOP, 14)  | 6.2mm × 7.8mm   | 6.20 mm × 5.30 mm  |
|             | NS (SOP, 14)   | 10.2mm × 7.8mm  | 10.30 mm × 5.30 mm |
|             | PW (TSSOP, 14) | 5mm × 4.4mm     | 5.00 mm × 4.40 mm  |
|             | RGY (VQFN, 14) | 3.5mm × 3.5mm   | 3.50 mm × 3.50 mm  |
|             | FK (LCCC, 20)  | 8.9mm × 8.9mm   | 8.89 mm × 8.89 mm  |
|             | J (CDIP, 14)   | 19.55mm × 7.9mm | 19.55 mm × 6.7mm   |
| W (CFP, 14) | 9.21mm × 9mm   | 9.21mm × 6.28mm |                    |

- 詳細については、[セクション 11](#) を参照してください。
- パッケージ サイズ (長さ × 幅) は公称値であり、該当する場合はピンも含まれます。
- 本体サイズ (長さ × 幅) は公称値であり、ピンは含まれません。



概略回路図



## Table of Contents

|  |   |  |    |
|--|---|--|----|
| <b>1 特長</b> .....  | 1 | <b>7 Detailed Description</b> .....                                  | 9  |
| <b>2 アプリケーション</b> .....                                  | 1 | 7.1 Overview.....  | 9  |
| <b>3 概要</b> .....  | 1 | 7.2 Functional Block Diagram.....                                    | 9  |
| <b>4 Pin Configuration and Functions</b> .....           | 3 | 7.3 Feature Description.....   | 9  |
| <b>5 Specifications</b> .....                            | 4 | 7.4 Device Functional Modes.....                                     | 10 |
| 5.1 Absolute Maximum Ratings.....                        | 4 | <b>8 Application and Implementation</b> .....                        | 11 |
| 5.2 ESD Ratings.....                                     | 4 | 8.1 Application Information.....                                     | 11 |
| 5.3 Recommended Operating Conditions,<br>SN54LVC00A..... | 4 | 8.2 Typical Application.....   | 11 |
| 5.4 Recommended Operating Conditions,<br>SN74LVC00A..... | 5 | 8.3 Layout.....  | 12 |
| 5.5 Thermal Information.....                             | 5 | <b>9 Device and Documentation Support</b> .....                      | 13 |
| 5.6 Electrical Characteristics, SN54LVC00A.....          | 6 | 9.1 Related Links.....   | 13 |
| 5.7 Electrical Characteristics, SN74LVC00A.....          | 6 | 9.2 Receiving Notification of Documentation Updates... 13            |    |
| 5.8 Switching Characteristics, SN54LVC00A.....           | 6 | 9.3 サポート・リソース.....   | 13 |
| 5.9 Switching Characteristics, SN74LVC00A.....           | 7 | 9.4 Trademarks.....  | 13 |
| 5.10 Operating Characteristics.....                      | 7 | 9.5 静電気放電に関する注意事項.....   | 13 |
| 5.11 Typical Characteristics.....                        | 7 | 9.6 用語集.....   | 13 |
| <b>6 Parameter Measurement Information</b> .....         | 8 | <b>11 Mechanical, Packaging, and Orderable<br/>Information</b> ..... | 14 |

## 4 Pin Configuration and Functions

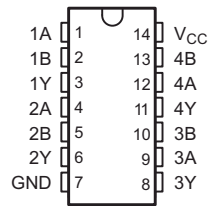
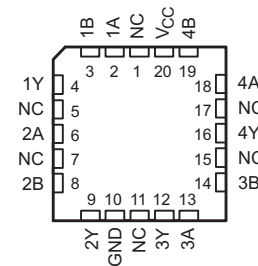


图 4-1. SN54LVC00A J or W Package; SN74LVC00A D, DB, NS, or PW Package 14-Pin CDIP, CFP SOIC, SSOP, SO, or TSSOP (Top View)



NC - No internal connection

图 4-2. SN54LVC00A FK Package 20-Pin LCCC (Top View)

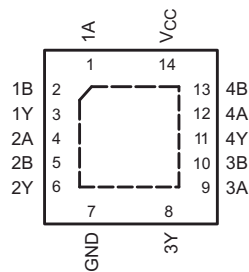


图 4-3. SN74LVC00A BQA or RGY Package 14-Pin WQFN or VQFN (Top View)

表 4-1. Pin Functions

| NAME            | PIN           |          |            |    | TYPE | DESCRIPTION     |
|-----------------|---------------|----------|------------|----|------|-----------------|
|                 | SN74LVC00A    |          | SN54LVC00A |    |      |                 |
|                 | D, DB, NS, PW | BQA, RGY | J, W       | FK |      |                 |
| 1A              | 1             | 1        | 1          | 2  | I    | Gate 1 input    |
| 1B              | 2             | 2        | 2          | 3  | I    | Gate 1 input    |
| 1Y              | 3             | 3        | 3          | 4  | O    | Gate 1 output   |
| 2A              | 4             | 4        | 4          | 6  | I    | Gate 2 input    |
| 2B              | 5             | 5        | 5          | 8  | I    | Gate 2 input    |
| 2Y              | 6             | 6        | 6          | 9  | O    | Gate 2 output   |
| GND             | 7             | 7        | 7          | 10 | I    | Ground Pin      |
| 3Y              | 8             | 8        | 8          | 12 | O    | Gate 3 output   |
| 3A              | 9             | 9        | 9          | 13 | I    | Gate 3 input    |
| 3B              | 10            | 10       | 10         | 14 | I    | Gate 3 input    |
| 4Y              | 11            | 11       | 11         | 16 | O    | Gate 4 output   |
| 4A              | 12            | 12       | 12         | 18 | I    | Gate 4 input    |
| 4B              | 13            | 13       | 13         | 19 | I    | Gate 4 input    |
| V <sub>CC</sub> | 14            | 14       | 14         | 20 | —    | Positive supply |
| NC              | —             | —        | —          | 1  | —    | No Connection   |
|                 |               |          |            | 5  |      |                 |
|                 |               |          |            | 7  |      |                 |
|                 |               |          |            | 11 |      |                 |
|                 |               |          |            | 15 |      |                 |
|                 |               |          |            | 17 |      |                 |

## 5 Specifications

### 5.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

|                  |                                      | MIN                              | MAX                   | UNIT |    |
|------------------|--------------------------------------|----------------------------------|-----------------------|------|----|
| V <sub>CC</sub>  | Supply voltage                       | -0.5                             | 6.5                   | V    |    |
| V <sub>I</sub>   | Input voltage <sup>(2)</sup>         | -0.5                             | 6.5                   | V    |    |
| V <sub>O</sub>   | Output voltage <sup>(2) (3)</sup>    | -0.5                             | V <sub>CC</sub> + 0.5 | V    |    |
| I <sub>IK</sub>  | Input clamp current                  | V <sub>I</sub> < 0               | -50                   | mA   |    |
| I <sub>OK</sub>  | Output clamp current                 | V <sub>O</sub> < 0               | -50                   | mA   |    |
| I <sub>O</sub>   | Continuous output current            |                                  | ±50                   | mA   |    |
| V <sub>CC</sub>  | Continuous current through GND       |                                  | ±100                  | mA   |    |
| P <sub>tot</sub> | Power dissipation <sup>(4) (5)</sup> | T <sub>A</sub> = -40°C to +125°C | 500                   | mW   |    |
| T <sub>J</sub>   | Junction temperature                 |                                  | 150                   | °C   |    |
| T <sub>stg</sub> | Storage temperature                  |                                  | -65                   | 150  | °C |

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.
- (3) The value of V<sub>CC</sub> is provided in the *Recommended Operating Conditions* table.
- (4) For the D package: above 70°C, the value of P<sub>tot</sub> derates linearly with 8 mW/K.
- (5) For the DB, NS, and PW packages: above 60°C, the value of P<sub>tot</sub> derates linearly with 5.5 mW/K.

### 5.2 ESD Ratings

|  |   | VALUE | UNIT |
|--|---|-------|------|
| V <sub>(ESD)</sub>   | Electrostatic discharge   |       |      |
|  | Human body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup> | ±2000 | V    |
| Charged device model (CDM), per JEDEC specification JESD22-C101 <sup>(2)</sup> | ±1000   |       |      |

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.
- (2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

### 5.3 Recommended Operating Conditions, SN54LVC00A

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

|                 |                           | SN54LVC00A                       |                 | UNIT |   |
|-----------------|---------------------------|----------------------------------|-----------------|------|---|
|                 |                           | -55°C to +125°C                  |                 |      |   |
|                 |                           | MIN                              | MAX             |      |   |
| V <sub>CC</sub> | Supply voltage            | Operating                        | 2               | 3.6  | V |
|                 |                           | Data retention only              | 1.5             |      |   |
| V <sub>IH</sub> | High-level input voltage  | V <sub>CC</sub> = 2.7 V to 3.6 V |                 | V    |   |
| V <sub>IL</sub> | Low-level input voltage   | V <sub>CC</sub> = 2.7 V to 3.6 V |                 | V    |   |
| V <sub>I</sub>  | Input voltage             | 0                                | 5.5             | V    |   |
| V <sub>O</sub>  | Output voltage            | 0                                | V <sub>CC</sub> | V    |   |
| I <sub>OH</sub> | High-level output current | V <sub>CC</sub> = 2.7 V          | -12             | mA   |   |
|                 |                           | V <sub>CC</sub> = 3 V            | -24             |      |   |
| I <sub>OL</sub> | Low-level output current  | V <sub>CC</sub> = 2.7 V          | 12              | mA   |   |
|                 |                           | V <sub>CC</sub> = 3 V            | 24              |      |   |

- (1) All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. See [Implications of Slow or Floating CMOS Inputs](#), SCBA004.

## 5.4 Recommended Operating Conditions, SN74LVC00A

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

|                 |                           | SN74LVC00A                         |                 |                        |                 |                        |                 | UNIT                   |                 |    |
|-----------------|---------------------------|------------------------------------|-----------------|------------------------|-----------------|------------------------|-----------------|------------------------|-----------------|----|
|                 |                           | T <sub>A</sub> = 25°C              |                 | –40°C to 85°C          |                 | –40°C to 125°C         |                 |                        |                 |    |
|                 |                           | MIN                                | MAX             | MIN                    | MAX             | MIN                    | MAX             |                        |                 |    |
| V <sub>CC</sub> | Supply voltage            | Operating                          |                 | 1.65                   | 3.6             | 1.65                   | 3.6             | 1.65                   | 3.6             | V  |
|                 |                           | Data retention only                |                 | 1.5                    |                 | 1.5                    |                 | 1.5                    |                 |    |
| V <sub>IH</sub> | High-level input voltage  | V <sub>CC</sub> = 1.65 V to 1.95 V |                 | 0.65 × V <sub>CC</sub> |                 | 0.65 × V <sub>CC</sub> |                 | 0.65 × V <sub>CC</sub> |                 | V  |
|                 |                           | V <sub>CC</sub> = 2.3 V to 2.7 V   |                 | 1.7                    |                 | 1.7                    |                 | 1.7                    |                 |    |
|                 |                           | V <sub>CC</sub> = 2.7 V to 3.6 V   |                 | 2                      |                 | 2                      |                 | 2                      |                 |    |
| V <sub>IL</sub> | Low-level input voltage   | V <sub>CC</sub> = 1.65 V to 1.95 V |                 | 0.35 × V <sub>CC</sub> |                 | 0.35 × V <sub>CC</sub> |                 | 0.35 × V <sub>CC</sub> |                 | V  |
|                 |                           | V <sub>CC</sub> = 2.3 V to 2.7 V   |                 | 0.7                    |                 | 0.7                    |                 | 0.7                    |                 |    |
|                 |                           | V <sub>CC</sub> = 2.7 V to 3.6 V   |                 | 0.8                    |                 | 0.8                    |                 | 0.8                    |                 |    |
| V <sub>I</sub>  | Input voltage             | 0                                  | 5.5             | 0                      | 5.5             | 0                      | 5.5             | 0                      | 5.5             | V  |
| V <sub>O</sub>  | Output voltage            | 0                                  | V <sub>CC</sub> | 0                      | V <sub>CC</sub> | 0                      | V <sub>CC</sub> | 0                      | V <sub>CC</sub> | V  |
| I <sub>OH</sub> | High-level output current | V <sub>CC</sub> = 1.65 V           |                 | –4                     |                 | –4                     |                 | –4                     |                 | mA |
|                 |                           | V <sub>CC</sub> = 2.3 V            |                 | –8                     |                 | –8                     |                 | –8                     |                 |    |
|                 |                           | V <sub>CC</sub> = 2.7 V            |                 | –12                    |                 | –12                    |                 | –12                    |                 |    |
|                 |                           | V <sub>CC</sub> = 3 V              |                 | –24                    |                 | –24                    |                 | –24                    |                 |    |
| I <sub>OL</sub> | Low-level output current  | V <sub>CC</sub> = 1.65 V           |                 | 4                      |                 | 4                      |                 | 4                      |                 | mA |
|                 |                           | V <sub>CC</sub> = 2.3 V            |                 | 8                      |                 | 8                      |                 | 8                      |                 |    |
|                 |                           | V <sub>CC</sub> = 2.7 V            |                 | 12                     |                 | 12                     |                 | 12                     |                 |    |
|                 |                           | V <sub>CC</sub> = 3 V              |                 | 24                     |                 | 24                     |                 | 24                     |                 |    |

(1) All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. See [Implications of Slow or Floating CMOS Inputs](#), SCBA004.

## 5.5 Thermal Information

| THERMAL METRIC <sup>(1)</sup> |  | SN74LVC00A |          |           |          |            |            | UNIT |
|-------------------------------|--|------------|----------|-----------|----------|------------|------------|------|
|                               |  | BQA (WQFN) | D (SOIC) | DB (SSOP) | NS (SOP) | PW (TSSOP) | RGY (VQFN) |      |
|                               |  | 14 PINS    | 14 PINS  | 14 PINS   | 14 PINS  | 14 PINS    | 14 PINS    |      |
| R <sub>θJA</sub>              | Junction-to-ambient thermal resistance | 102.3      | 127.8    | 140.4     | 123.8    | 150.8      | 92.1       | °C/W |

(1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics](#) application report.

## 5.6 Electrical Characteristics, SN54LVC00A

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER        | TEST CONDITIONS  | V <sub>CC</sub> | SN54LVC00A            |     | UNIT |
|------------------|--|-----------------|-----------------------|-----|------|
|                  |  |                 | –55°C to +125°C       |     |      |
|                  |  |                 | MIN                   | MAX |      |
| V <sub>OH</sub>  | I <sub>OH</sub> = –100 μA  | 2.7 V to 3.6 V  | V <sub>CC</sub> – 0.2 |     | V    |
|                  | I <sub>OH</sub> = –12 mA   | 2.7 V           | 2.2                   |     |      |
|                  | I <sub>OH</sub> = –24 mA   | 3 V             | 2.4                   |     |      |
| V <sub>OL</sub>  | I <sub>OL</sub> = 100 μA   | 2.7 V to 3.6 V  | 0.2                   |     | V    |
|                  | I <sub>OL</sub> = 12 mA  | 2.7 V           | 0.4                   |     |      |
|                  | I <sub>OL</sub> = 24 mA  | 3 V             | 0.55                  |     |      |
| I <sub>I</sub>   | V <sub>I</sub> = 5.5 V or GND  | 3.6 V           | ±5                    |     | μA   |
| I <sub>CC</sub>  | V <sub>I</sub> = V <sub>CC</sub> or GND, I <sub>O</sub> = 0                  | 3.6 V           | 10                    |     | μA   |
| ΔI <sub>CC</sub> | One input at V <sub>CC</sub> – 0.6 V, Other inputs at V <sub>CC</sub> or GND | 2.7 V to 3.6 V  | 500                   |     | μA   |

## 5.7 Electrical Characteristics, SN74LVC00A

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER                | TEST CONDITIONS  | V <sub>CC</sub> | SN74LVC00A            |     |     |                       |     |                       | UNIT |     |
|--------------------------|--|-----------------|-----------------------|-----|-----|-----------------------|-----|-----------------------|------|-----|
|                          |  |                 | T <sub>A</sub> = 25°C |     |     | –40°C to +85°C        |     | –40°C to +125°C       |      |     |
|                          |  |                 | MIN                   | TYP | MAX | MIN                   | MAX | MIN                   |      | MAX |
| V <sub>OH</sub>          | I <sub>OH</sub> = –100 μA  | 1.65 V to 3.6 V | V <sub>CC</sub> – 0.2 |     |     | V <sub>CC</sub> – 0.2 |     | V <sub>CC</sub> – 0.3 |      | V   |
|                          | I <sub>OH</sub> = –4 mA  | 1.65 V          | 1.29                  |     |     | 1.2                   |     | 1.05                  |      |     |
|                          | I <sub>OH</sub> = –8 mA  | 2.3 V           | 1.9                   |     |     | 1.7                   |     | 1.55                  |      |     |
|                          | I <sub>OH</sub> = –12 mA   | 2.7 V           | 2.2                   |     |     | 2.2                   |     | 2.05                  |      |     |
|                          |  | 3 V             | 2.4                   |     |     | 2.4                   |     | 2.25                  |      |     |
| I <sub>OH</sub> = –24 mA | 3 V  | 2.3             |                       |     | 2.2 |                       | 2   |                       |      |     |
| V <sub>OL</sub>          | I <sub>OL</sub> = 100 μA   | 1.65 V to 3.6 V |                       |     |     | 0.1                   |     | 0.2                   |      | V   |
|                          | I <sub>OL</sub> = 4 mA   | 1.65 V          |                       |     |     | 0.24                  |     | 0.45                  |      |     |
|                          | I <sub>OL</sub> = 8 mA   | 2.3 V           |                       |     |     | 0.3                   |     | 0.7                   |      |     |
|                          | I <sub>OL</sub> = 12 mA  | 2.7 V           |                       |     |     | 0.4                   |     | 0.6                   |      |     |
|                          | I <sub>OL</sub> = 24 mA  | 3 V             |                       |     |     | 0.55                  |     | 0.8                   |      |     |
| I <sub>I</sub>           | V <sub>I</sub> = 5.5 V or GND  | 3.6 V           |                       |     |     | ±1                    |     | ±5                    |      | μA  |
| I <sub>CC</sub>          | V <sub>I</sub> = V <sub>CC</sub> or GND, I <sub>O</sub> = 0                  | 3.6 V           |                       |     |     | 1                     |     | 10                    |      | μA  |
| ΔI <sub>CC</sub>         | One input at V <sub>CC</sub> – 0.6 V, Other inputs at V <sub>CC</sub> or GND | 2.7 V to 3.6 V  |                       |     |     | 500                   |     | 500                   |      | μA  |
| C <sub>i</sub>           | V <sub>I</sub> = V <sub>CC</sub> or GND                                      | 3.3 V           |                       |     |     | 5                     |     |                       |      | pF  |

## 5.8 Switching Characteristics, SN54LVC00A

over recommended operating free-air temperature range (unless otherwise noted) (see [Load Circuit and Voltage Waveforms](#))

| PARAMETER       | FROM (INPUT) | TO (OUTPUT) | V <sub>CC</sub> | SN54LVC00A      |     | UNIT |
|-----------------|--------------|-------------|-----------------|-----------------|-----|------|
|                 |              |             |                 | –55°C to +125°C |     |      |
|                 |              |             |                 | MIN             | MAX |      |
| t <sub>pd</sub> | A or B       | Y           | 2.7 V           | 5.1             |     | ns   |
|                 |              |             | 3.3 V ± 0.3 V   | 1               | 4.3 |      |

### 5.9 Switching Characteristics, SN74LVC00A

over recommended operating free-air temperature range (unless otherwise noted) (see [Load Circuit and Voltage Waveforms](#))

| PARAMETER          | FROM (INPUT) | TO (OUTPUT) | V <sub>CC</sub> | SN74LVC00A            |     |     |                |      |                 | UNIT |     |
|--------------------|--------------|-------------|-----------------|-----------------------|-----|-----|----------------|------|-----------------|------|-----|
|                    |              |             |                 | T <sub>A</sub> = 25°C |     |     | –40°C to +85°C |      | –40°C to +125°C |      |     |
|                    |              |             |                 | MIN                   | TYP | MAX | MIN            | MAX  | MIN             |      | MAX |
| t <sub>pd</sub>    | A or B       | Y           | 1.8 V ± 0.15 V  | 1                     | 6   | 12  | 1              | 12.5 | 1               | 14   | ns  |
|                    |              |             | 2.5 V ± 0.2 V   | 1                     | 4.6 | 5.9 | 1              | 6.4  | 1               | 7.9  |     |
|                    |              |             | 2.7 V           | 1                     | 4.3 | 4.9 | 1              | 5.1  | 1               | 6.5  |     |
|                    |              |             | 3.3 V ± 0.3 V   | 1                     | 3.5 | 4.1 | 1              | 4.3  | 1               | 5.5  |     |
| t <sub>sk(o)</sub> |              |             | 3.3 V ± 0.3 V   |                       |     |     |                | 1    |                 | 1.5  | ns  |

### 5.10 Operating Characteristics

T<sub>A</sub> = 25°C

| PARAMETER       |  | TEST CONDITIONS | V <sub>CC</sub> | TYP | UNIT |
|-----------------|--|-----------------|-----------------|-----|------|
| C <sub>pd</sub> | Power dissipation capacitance per gate | f = 10 MHz      | 1.8 V           | 18  | pF   |
|                 |  |                 | 2.5 V           | 18  |      |
|                 |  |                 | 3.3 V           | 19  |      |

### 5.11 Typical Characteristics

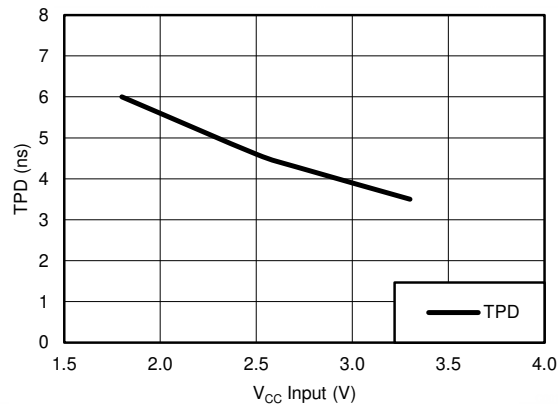
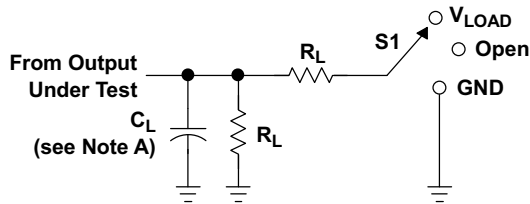


図 5-1. TPD vs V<sub>CC</sub> (T<sub>A</sub> = 25°C)

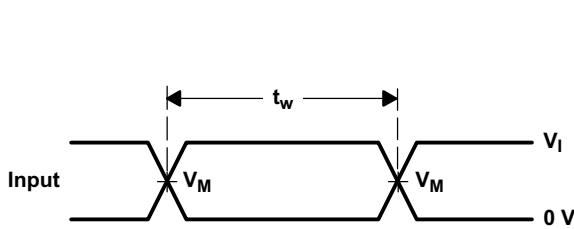
## 6 Parameter Measurement Information



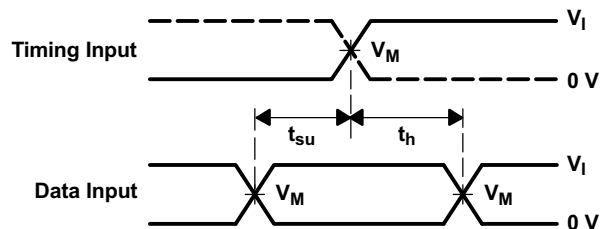
LOAD CIRCUIT

| TEST              | S1         |
|-------------------|------------|
| $t_{PLH}/t_{PHL}$ | Open       |
| $t_{PLZ}/t_{PZL}$ | $V_{LOAD}$ |
| $t_{PHZ}/t_{PZH}$ | GND        |

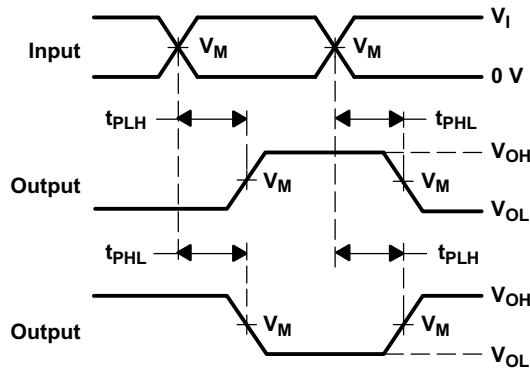
| $V_{CC}$                         | INPUTS   |                      | $V_M$      | $V_{LOAD}$        | $C_L$ | $R_L$        | $V_{\Delta}$ |
|----------------------------------|----------|----------------------|------------|-------------------|-------|--------------|--------------|
|                                  | $V_I$    | $t_r/t_f$            |            |                   |       |              |              |
| $1.8\text{ V} \pm 0.15\text{ V}$ | $V_{CC}$ | $\leq 2\text{ ns}$   | $V_{CC}/2$ | $2 \times V_{CC}$ | 30 pF | 1 k $\Omega$ | 0.15 V       |
| $2.5\text{ V} \pm 0.2\text{ V}$  | $V_{CC}$ | $\leq 2\text{ ns}$   | $V_{CC}/2$ | $2 \times V_{CC}$ | 30 pF | 500 $\Omega$ | 0.15 V       |
| 2.7 V                            | 2.7 V    | $\leq 2.5\text{ ns}$ | 1.5 V      | 6 V               | 50 pF | 500 $\Omega$ | 0.3 V        |
| $3.3\text{ V} \pm 0.3\text{ V}$  | 2.7 V    | $\leq 2.5\text{ ns}$ | 1.5 V      | 6 V               | 50 pF | 500 $\Omega$ | 0.3 V        |



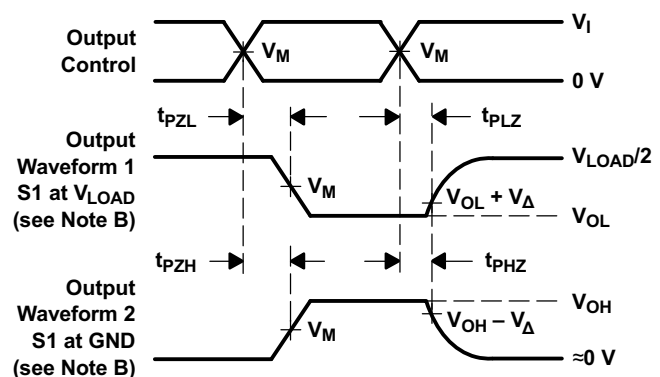
VOLTAGE WAVEFORMS  
PULSE DURATION



VOLTAGE WAVEFORMS  
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS  
PROPAGATION DELAY TIMES  
INVERTING AND NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS  
ENABLE AND DISABLE TIMES  
LOW- AND HIGH-LEVEL ENABLING

- NOTES:
- A.  $C_L$  includes probe and jig capacitance.
  - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
  - C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq 10\text{ MHz}$ ,  $Z_O = 50\ \Omega$ .
  - D. The outputs are measured one at a time, with one transition per measurement.
  - E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
  - F.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
  - G.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .
  - H. All parameters and waveforms are not applicable to all devices.

图 6-1. Load Circuit and Voltage Waveforms

## 7 Detailed Description

### 7.1 Overview

The maximum sink and source current is 24 mA.

Inputs can be driven from 1.8-V, 2.5-V, 3.3-V (LVTTTL), or 5-V (CMOS) devices. This feature allows the use of this device as translators in a mixed-system environment.

### 7.2 Functional Block Diagram



図 7-1. Logic Diagram, Each Gate (Positive Logic)

### 7.3 Feature Description

#### 7.3.1 Balanced High-Drive CMOS Push-Pull Outputs

A balanced output allows the device to sink and source similar currents. The high drive capability of this device creates fast edges into light loads so routing and load conditions should be considered to prevent ringing. Additionally, the outputs of this device are capable of driving larger currents than the device can sustain without being damaged. It is important for the power output of the device to be limited to avoid thermal runaway and damage due to over-current. The electrical and thermal limits defined in the [セクション 5.1](#) must be followed at all times.

#### 7.3.2 Standard CMOS Inputs

Standard CMOS inputs are high impedance and are typically modelled as a resistor in parallel with the input capacitance given in the [セクション 5.6](#) and [セクション 5.7](#). The worst case resistance is calculated with the maximum input voltage, given in the [セクション 5.1](#), and the maximum input leakage current, given in the [セクション 5.6](#) and [セクション 5.7](#), using ohm's law ( $R = V \div I$ ).

Signals applied to the inputs need to have fast edge rates, as defined by  $\Delta t/\Delta v$  in [セクション 5.3](#) and [セクション 5.4](#) to avoid excessive currents and oscillations. If a slow or noisy input signal is required, a device with a Schmitt-trigger input should be utilized to condition the input signal prior to the standard CMOS input.

#### 7.3.3 Clamp Diodes

The inputs and outputs to this device have negative clamping diodes.

#### 注意

Voltages beyond the values specified in the [セクション 5.1](#) table can cause damage to the device. The input negative-voltage and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

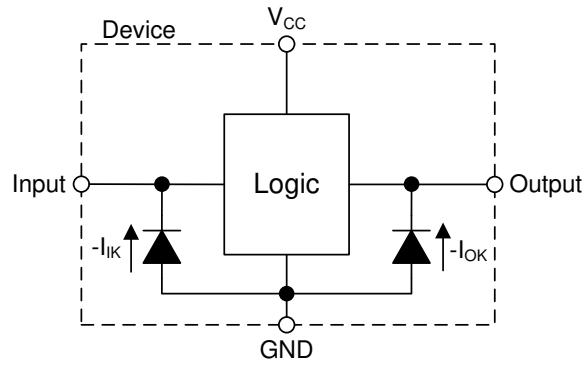


図 7-2. Electrical Placement of Clamping Diodes for Each Input and Output

### 7.3.4 Over-voltage Tolerant Inputs

Input signals to this device can be driven above the supply voltage so long as they remain below the maximum input voltage value specified in the [セクション 5.1](#).

### 7.4 Device Functional Modes

表 7-1 lists the functional modes of SN54LVC00A and SN74LVC00A.

表 7-1. Function Table  
(Each Gate)

| INPUTS |   | OUTPUT |
|--------|---|--------|
| A      | B | Y      |
| H      | H | L      |
| L      | X | H      |
| X      | L | H      |

## 8 Application and Implementation

### 注

以下のアプリケーション情報は、TI の製品仕様に含まれるものではなく、TI ではその正確性または完全性を保証いたしません。個々の目的に対する製品の適合性については、お客様の責任で判断していただくことになります。お客様は自身の設計実装を検証しテストすることで、システムの機能を確認する必要があります。

### 8.1 Application Information

SN74LVC00A is a high-drive CMOS device that can be used for a multitude of buffer-type functions. It can produce 24 mA of drive current at 3.3 V. Therefore, this device is ideal for driving multiple inputs and for high-speed applications up to 100 MHz. The inputs and outputs are 5.5-V tolerant allowing the device to allowing the device to perform mixed-voltage input down translation. For example the A input can be 3.3 V and the B input can be 5 V, while  $V_{CC} = 2.5$  V and the device will operate properly to output a 2.5 V signal.

### 8.2 Typical Application

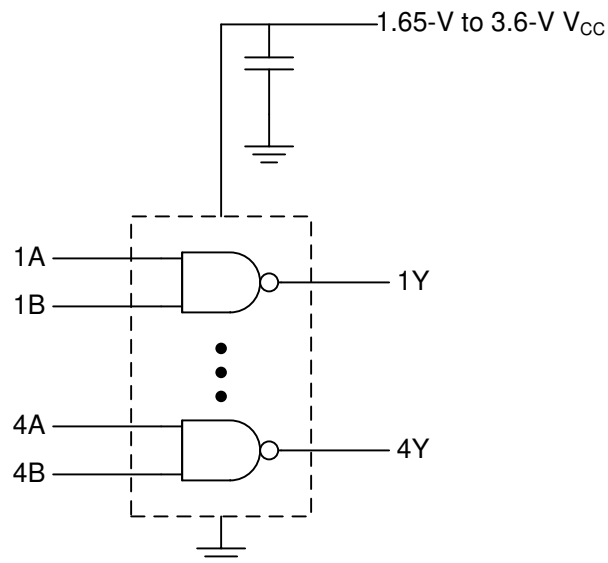


図 8-1. Typical NAND Gate Application and Supply Voltage

#### 8.2.1 Design Requirements

This device uses CMOS technology and has balanced output drive. Take care to avoid bus contention because it can drive currents that would exceed maximum limits. The high drive will also create fast edges into light loads; therefore, routing and load conditions should be considered to prevent ringing.

#### 8.2.2 Detailed Design Procedure

1. Recommended Input Conditions
  - Rise time and fall time specs: See  $(\Delta t/\Delta V)$  in the [セクション 5.4](#) table.
  - Specified high and low levels: See  $(V_{IH}$  and  $V_{IL})$  in the [セクション 5.4](#) table.
  - Inputs are overvoltage tolerant allowing them to go as high as 5.5 V at any valid  $V_{CC}$ .
2. Recommended Output Conditions
  - Load currents should not exceed 25 mA per output and 50 mA total for the part.
  - Outputs should not be pulled above 5.5 V.

### 8.2.3 Application Curve

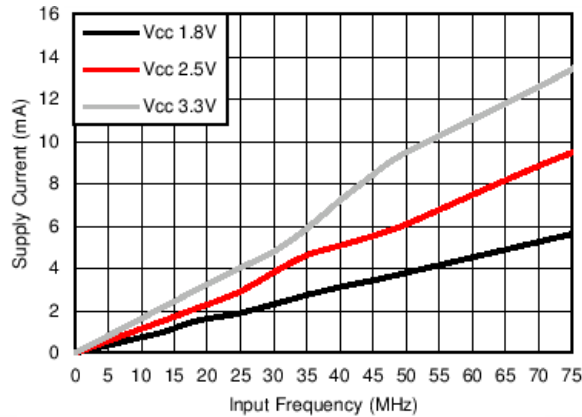


図 8-2. I<sub>CC</sub> vs Frequency

### Power Supply Recommendations

The power supply can be any voltage between the MIN and MAX supply voltage rating located in the [セクション 5.4](#) table.

Each V<sub>CC</sub> pin should have a good bypass capacitor to prevent power disturbance. For devices with a single supply, 0.1 μF is recommended; if there are multiple V<sub>CC</sub> pins, then 0.01 μF or 0.022 μF is recommended for each power pin. It is acceptable to parallel multiple bypass caps to reject different frequencies of noise. A 0.1 μF and a 1 μF are commonly used in parallel. The bypass capacitor should be installed as close to the power pin as possible for best results.

### 8.3 Layout

#### 8.3.1 Layout Guidelines

When using multiple bit logic devices inputs should never float.

In many cases, functions or parts of functions of digital logic devices are unused, for example, when only two inputs of a triple-input AND gate are used or only 3 of the 4 buffer gates are used. Such input pins should not be left unconnected because the undefined voltages at the outside connections result in undefined operational states. [セクション 8.3.2](#) specifies the rules that must be observed under all circumstances. All unused inputs of digital logic devices must be connected to a high or low bias to prevent them from floating. The logic level that should be applied to any particular unused input depends on the function of the device. Generally they will be tied to GND or V<sub>CC</sub>, whichever makes more sense or is more convenient. It is generally acceptable to float outputs, unless the part is a transceiver.

#### 8.3.2 Layout Example

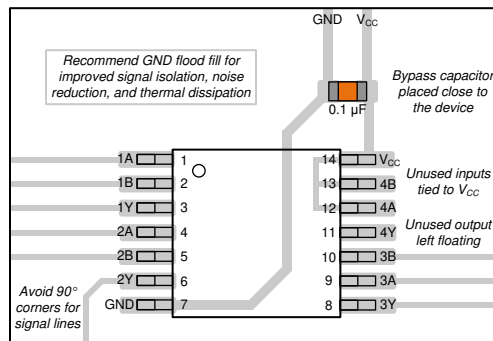


図 8-3. Layout Diagram for the SNx4LVC00A

## 9 Device and Documentation Support

### 9.1 Related Links

The table below lists quick access links. Categories include technical documents, support and community resources, tools and software, and quick access to order now.

表 9-1. Related Links

| PARTS      | PRODUCT FOLDER             | ORDER NOW                  | TECHNICAL DOCUMENTS        | TOOLS & SOFTWARE           | SUPPORT & COMMUNITY        |
|------------|----------------------------|----------------------------|----------------------------|----------------------------|----------------------------|
| SN54LVC00A | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |
| SN74LVC00A | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |

### 9.2 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. In the upper right corner, click on *Alert me* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

### 9.3 サポート・リソース

[テキサス・インスツルメンツ E2E™ サポート・フォーラム](#)は、エンジニアが検証済みの回答と設計に関するヒントをエキスパートから迅速かつ直接得ることができる場所です。既存の回答を検索したり、独自の質問をしたりすることで、設計に必要な支援を迅速に得ることができます。

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#### 9.3.1 Community Resources

### 9.4 Trademarks

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### 9.5 静電気放電に関する注意事項



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### 9.6 用語集

[テキサス・インスツルメンツ用語集](#) この用語集には、用語や略語の一覧および定義が記載されています。

## 10

資料番号末尾の英字は改訂を表しています。その改訂履歴は英語版に準じています。

#### Changes from Revision T (May 2024) to Revision U (July 2024) Page

- Updated R $\theta$ JA values: D = 86 to 127.8, all values in °C/W.....5
- Added *Typical Characteristics* ..... 7

#### Changes from Revision S (March 2024) to Revision T (May 2024) Page

- Updated R $\theta$ JA values: DB = 96 to 140.4, NS = 76 to 123.8, PW = 113 to 150.8, RGY = 47 to 92.1; Updated DB, NS, PW, and RGY packages for R $\theta$ JC(top), R $\theta$ JB,  $\Psi$ JT,  $\Psi$ JB, and R $\theta$ JC(bot), all values in °C/W.....5

## 11 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

**PACKAGING INFORMATION**

| Orderable part number           | Status<br>(1) | Material type<br>(2) | Package   Pins  | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6)                      |
|---------------------------------|---------------|----------------------|-----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|--|
| <a href="#">5962-9753301Q2A</a> | Active        | Production           | LCCC (FK)   20  | 55   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | 5962-<br>9753301Q2A<br>SNJ54LVC<br>00AFK |
| <a href="#">5962-9753301QCA</a> | Active        | Production           | CDIP (J)   14   | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | 5962-9753301QC<br>A<br>SNJ54LVC00AJ      |
| <a href="#">5962-9753301QDA</a> | Active        | Production           | CFP (W)   14    | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | 5962-9753301QD<br>A<br>SNJ54LVC00AW      |
| <a href="#">5962-9753301VDA</a> | Active        | Production           | CFP (W)   14    | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | 5962-9753301VD<br>A<br>SNV54LVC00AW      |
| <a href="#">SN74LVC00ABQAR</a>  | Active        | Production           | WQFN (BQA)   14 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | LVC00A                                   |
| SN74LVC00ABQAR.A                | Active        | Production           | WQFN (BQA)   14 | 3000   LARGE T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | LVC00A                                   |
| <a href="#">SN74LVC00AD</a>     | Active        | Production           | SOIC (D)   14   | 50   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | LVC00A                                   |
| SN74LVC00AD.B                   | Active        | Production           | SOIC (D)   14   | 50   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | LVC00A                                   |
| <a href="#">SN74LVC00ADBR</a>   | Active        | Production           | SSOP (DB)   14  | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | LC00A                                    |
| SN74LVC00ADBR.A                 | Active        | Production           | SSOP (DB)   14  | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | LC00A                                    |
| SN74LVC00ADBR.B                 | Active        | Production           | SSOP (DB)   14  | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | LC00A                                    |
| SN74LVC00ADBRG4                 | Active        | Production           | SSOP (DB)   14  | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | LC00A                                    |
| SN74LVC00ADE4                   | Active        | Production           | SOIC (D)   14   | 50   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | LVC00A                                   |
| <a href="#">SN74LVC00ADR</a>    | Active        | Production           | SOIC (D)   14   | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | LVC00A                                   |
| SN74LVC00ADR.A                  | Active        | Production           | SOIC (D)   14   | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | LVC00A                                   |
| SN74LVC00ADR.B                  | Active        | Production           | SOIC (D)   14   | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | LVC00A                                   |
| SN74LVC00ADRG4                  | Active        | Production           | SOIC (D)   14   | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | LVC00A                                   |
| <a href="#">SN74LVC00ADT</a>    | Active        | Production           | SOIC (D)   14   | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | LVC00A                                   |
| SN74LVC00ADT.B                  | Active        | Production           | SOIC (D)   14   | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | LVC00A                                   |
| <a href="#">SN74LVC00ANSR</a>   | Active        | Production           | SOP (NS)   14   | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | LVC00A                                   |
| SN74LVC00ANSR.A                 | Active        | Production           | SOP (NS)   14   | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | LVC00A                                   |
| SN74LVC00ANSR.B                 | Active        | Production           | SOP (NS)   14   | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | LVC00A                                   |

| Orderable part number           | Status<br>(1) | Material type<br>(2) | Package   Pins  | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6)                 |
|---------------------------------|---------------|----------------------|-----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|-------------------------------------|
| SN74LVC00ANSRG4                 | Active        | Production           | SOP (NS)   14   | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | LVC00A                              |
| <a href="#">SN74LVC00APW</a>    | Active        | Production           | TSSOP (PW)   14 | 90   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | LC00A                               |
| SN74LVC00APW.B                  | Active        | Production           | TSSOP (PW)   14 | 90   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | LC00A                               |
| SN74LVC00APWE4                  | Active        | Production           | TSSOP (PW)   14 | 90   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | LC00A                               |
| SN74LVC00APWG4                  | Active        | Production           | TSSOP (PW)   14 | 90   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | LC00A                               |
| <a href="#">SN74LVC00APWR</a>   | Active        | Production           | TSSOP (PW)   14 | 2000   LARGE T&R      | Yes         | Call TI   Sn   Nipdau                | Level-1-260C-UNLIM                | -40 to 125   | LC00A                               |
| SN74LVC00APWR.A                 | Active        | Production           | TSSOP (PW)   14 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | LC00A                               |
| SN74LVC00APWR.B                 | Active        | Production           | TSSOP (PW)   14 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | LC00A                               |
| SN74LVC00APWRE4                 | Active        | Production           | TSSOP (PW)   14 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | LC00A                               |
| <a href="#">SN74LVC00APWRG4</a> | Active        | Production           | TSSOP (PW)   14 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | LC00A                               |
| SN74LVC00APWRG4.A               | Active        | Production           | TSSOP (PW)   14 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | LC00A                               |
| SN74LVC00APWRG4.B               | Active        | Production           | TSSOP (PW)   14 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | LC00A                               |
| <a href="#">SN74LVC00APWT</a>   | Active        | Production           | TSSOP (PW)   14 | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | LC00A                               |
| SN74LVC00APWT.B                 | Active        | Production           | TSSOP (PW)   14 | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | LC00A                               |
| <a href="#">SN74LVC00ARGYR</a>  | Active        | Production           | VQFN (RGY)   14 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | LC00A                               |
| SN74LVC00ARGYR.A                | Active        | Production           | VQFN (RGY)   14 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | LC00A                               |
| SN74LVC00ARGYR.B                | Active        | Production           | VQFN (RGY)   14 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | LC00A                               |
| SN74LVC00ARGYRG4                | Active        | Production           | VQFN (RGY)   14 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | LC00A                               |
| SN74LVC00ARGYRG4.A              | Active        | Production           | VQFN (RGY)   14 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | LC00A                               |
| SN74LVC00ARGYRG4.B              | Active        | Production           | VQFN (RGY)   14 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 125   | LC00A                               |
| <a href="#">SNJ54LVC00AFK</a>   | Active        | Production           | LCCC (FK)   20  | 55   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | 5962-9753301Q2A<br>SNJ54LVC00AFK    |
| <a href="#">SNJ54LVC00AJ</a>    | Active        | Production           | CDIP (J)   14   | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | 5962-9753301QC<br>A<br>SNJ54LVC00AJ |
| <a href="#">SNJ54LVC00AW</a>    | Active        | Production           | CFP (W)   14    | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | 5962-9753301QD<br>A<br>SNJ54LVC00AW |

(1) **Status:** For more details on status, see our [product life cycle](#).

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

**Important Information and Disclaimer:** The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

**OTHER QUALIFIED VERSIONS OF SN54LVC00A, SN54LVC00A-SP, SN74LVC00A :**

- Catalog : [SN74LVC00A](#), [SN54LVC00A](#)
- Automotive : [SN74LVC00A-Q1](#), [SN74LVC00A-Q1](#)
- Enhanced Product : [SN74LVC00A-EP](#), [SN74LVC00A-EP](#)
- Military : [SN54LVC00A](#)
- Space : [SN54LVC00A-SP](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product
- Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects
- Enhanced Product - Supports Defense, Aerospace and Medical Applications
- Military - QML certified for Military and Defense Applications
- Space - Radiation tolerant, ceramic packaging and qualified for use in Space-based application

**TAPE AND REEL INFORMATION**

**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**


\*All dimensions are nominal

| Device           | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|------------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| SN74LVC00ABQAR   | WQFN         | BQA             | 14   | 3000 | 180.0              | 12.4               | 2.8     | 3.3     | 1.1     | 4.0     | 12.0   | Q1            |
| SN74LVC00ADBRR   | SSOP         | DB              | 14   | 2000 | 330.0              | 16.4               | 8.35    | 6.6     | 2.4     | 12.0    | 16.0   | Q1            |
| SN74LVC00ADR     | SOIC         | D               | 14   | 2500 | 330.0              | 16.4               | 6.5     | 9.0     | 2.1     | 8.0     | 16.0   | Q1            |
| SN74LVC00ADT     | SOIC         | D               | 14   | 250  | 330.0              | 16.4               | 6.5     | 9.0     | 2.1     | 8.0     | 16.0   | Q1            |
| SN74LVC00ANSR    | SOP          | NS              | 14   | 2000 | 330.0              | 16.4               | 8.1     | 10.4    | 2.5     | 12.0    | 16.0   | Q1            |
| SN74LVC00APWR    | TSSOP        | PW              | 14   | 2000 | 330.0              | 12.4               | 6.9     | 5.6     | 1.6     | 8.0     | 12.0   | Q1            |
| SN74LVC00APWRG4  | TSSOP        | PW              | 14   | 2000 | 330.0              | 12.4               | 6.9     | 5.6     | 1.6     | 8.0     | 12.0   | Q1            |
| SN74LVC00APWT    | TSSOP        | PW              | 14   | 250  | 330.0              | 12.4               | 6.9     | 5.6     | 1.6     | 8.0     | 12.0   | Q1            |
| SN74LVC00ARGYR   | VQFN         | RGY             | 14   | 3000 | 330.0              | 12.4               | 3.75    | 3.75    | 1.15    | 8.0     | 12.0   | Q1            |
| SN74LVC00ARGYRG4 | VQFN         | RGY             | 14   | 3000 | 330.0              | 12.4               | 3.75    | 3.75    | 1.15    | 8.0     | 12.0   | Q1            |

**TAPE AND REEL BOX DIMENSIONS**


\*All dimensions are nominal

| Device           | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74LVC00ABQAR   | WQFN         | BQA             | 14   | 3000 | 210.0       | 185.0      | 35.0        |
| SN74LVC00ADBR    | SSOP         | DB              | 14   | 2000 | 353.0       | 353.0      | 32.0        |
| SN74LVC00ADR     | SOIC         | D               | 14   | 2500 | 353.0       | 353.0      | 32.0        |
| SN74LVC00ADT     | SOIC         | D               | 14   | 250  | 213.0       | 191.0      | 35.0        |
| SN74LVC00ANSR    | SOP          | NS              | 14   | 2000 | 353.0       | 353.0      | 32.0        |
| SN74LVC00APWR    | TSSOP        | PW              | 14   | 2000 | 353.0       | 353.0      | 32.0        |
| SN74LVC00APWRG4  | TSSOP        | PW              | 14   | 2000 | 353.0       | 353.0      | 32.0        |
| SN74LVC00APWT    | TSSOP        | PW              | 14   | 250  | 353.0       | 353.0      | 32.0        |
| SN74LVC00ARGYR   | VQFN         | RGY             | 14   | 3000 | 360.0       | 360.0      | 36.0        |
| SN74LVC00ARGYRG4 | VQFN         | RGY             | 14   | 3000 | 353.0       | 353.0      | 32.0        |

**TUBE**


\*All dimensions are nominal

| Device          | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|-----------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| 5962-9753301Q2A | FK           | LCCC         | 20   | 55  | 506.98 | 12.06  | 2030   | NA     |
| 5962-9753301QDA | W            | CFP          | 14   | 25  | 506.98 | 26.16  | 6220   | NA     |
| 5962-9753301VDA | W            | CFP          | 14   | 25  | 506.98 | 26.16  | 6220   | NA     |
| SN74LVC00AD     | D            | SOIC         | 14   | 50  | 506.6  | 8      | 3940   | 4.32   |
| SN74LVC00AD.B   | D            | SOIC         | 14   | 50  | 506.6  | 8      | 3940   | 4.32   |
| SN74LVC00ADE4   | D            | SOIC         | 14   | 50  | 506.6  | 8      | 3940   | 4.32   |
| SN74LVC00APW    | PW           | TSSOP        | 14   | 90  | 530    | 10.2   | 3600   | 3.5    |
| SN74LVC00APW.B  | PW           | TSSOP        | 14   | 90  | 530    | 10.2   | 3600   | 3.5    |
| SN74LVC00APWE4  | PW           | TSSOP        | 14   | 90  | 530    | 10.2   | 3600   | 3.5    |
| SN74LVC00APWG4  | PW           | TSSOP        | 14   | 90  | 530    | 10.2   | 3600   | 3.5    |
| SNJ54LVC00AFK   | FK           | LCCC         | 20   | 55  | 506.98 | 12.06  | 2030   | NA     |
| SNJ54LVC00AW    | W            | CFP          | 14   | 25  | 506.98 | 26.16  | 6220   | NA     |

W (R-GDFP-F14)

CERAMIC DUAL FLATPACK



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package can be hermetically sealed with a ceramic lid using glass frit.
  - D. Index point is provided on cap for terminal identification only.
  - E. Falls within MIL STD 1835 GDFP1-F14

# DB0014A



# PACKAGE OUTLINE

## SSOP - 2 mm max height

SMALL OUTLINE PACKAGE



### NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. Reference JEDEC registration MO-150.

# EXAMPLE BOARD LAYOUT

DB0014A

SSOP - 2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE: 10X



4220762/A 05/2024

NOTES: (continued)

- 5. Publication IPC-7351 may have alternate designs.
- 6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

DB0014A

SSOP - 2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE: 10X

4220762/A 05/2024

NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.

## GENERIC PACKAGE VIEW

**FK 20**

**LCCC - 2.03 mm max height**

8.89 x 8.89, 1.27 mm pitch

LEADLESS CERAMIC CHIP CARRIER

This image is a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.



4229370VA\

J 14

**GENERIC PACKAGE VIEW**  
**CDIP - 5.08 mm max height**  
CERAMIC DUAL IN LINE PACKAGE



Images above are just a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.

4040083-5/G

J0014A



# PACKAGE OUTLINE

CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE



4214771/A 05/2017

NOTES:

1. All controlling linear dimensions are in inches. Dimensions in brackets are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This package is hermetically sealed with a ceramic lid using glass frit.
4. Index point is provided on cap for terminal identification only and on press ceramic glass frit seal only.
5. Falls within MIL-STD-1835 and GDIP1-T14.

# EXAMPLE BOARD LAYOUT

J0014A

CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE

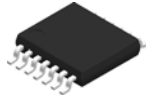


LAND PATTERN EXAMPLE  
NON-SOLDER MASK DEFINED  
SCALE: 5X



4214771/A 05/2017

PW0014A



# PACKAGE OUTLINE

## TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



4220202/B 12/2023

NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
5. Reference JEDEC registration MO-153.

# EXAMPLE BOARD LAYOUT

PW0014A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE: 10X



4220202/B 12/2023

NOTES: (continued)

- 6. Publication IPC-7351 may have alternate designs.
- 7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

PW0014A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE: 10X

4220202/B 12/2023

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

## GENERIC PACKAGE VIEW

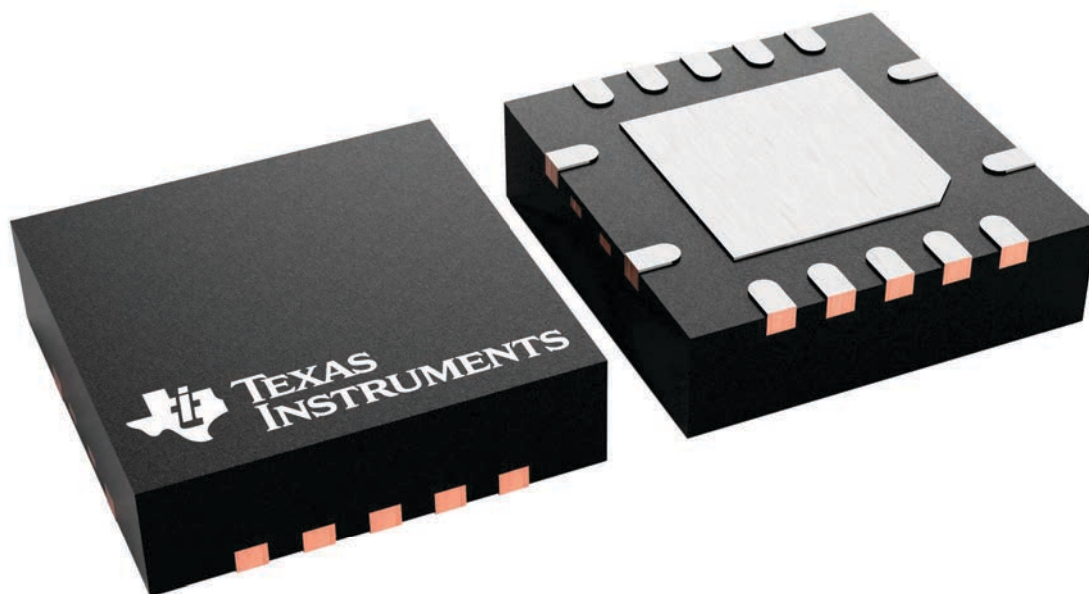
**RGY 14**

**VQFN - 1 mm max height**

3.5 x 3.5, 0.5 mm pitch

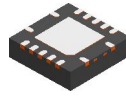
PLASTIC QUAD FLATPACK - NO LEAD

This image is a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.



4231541/A

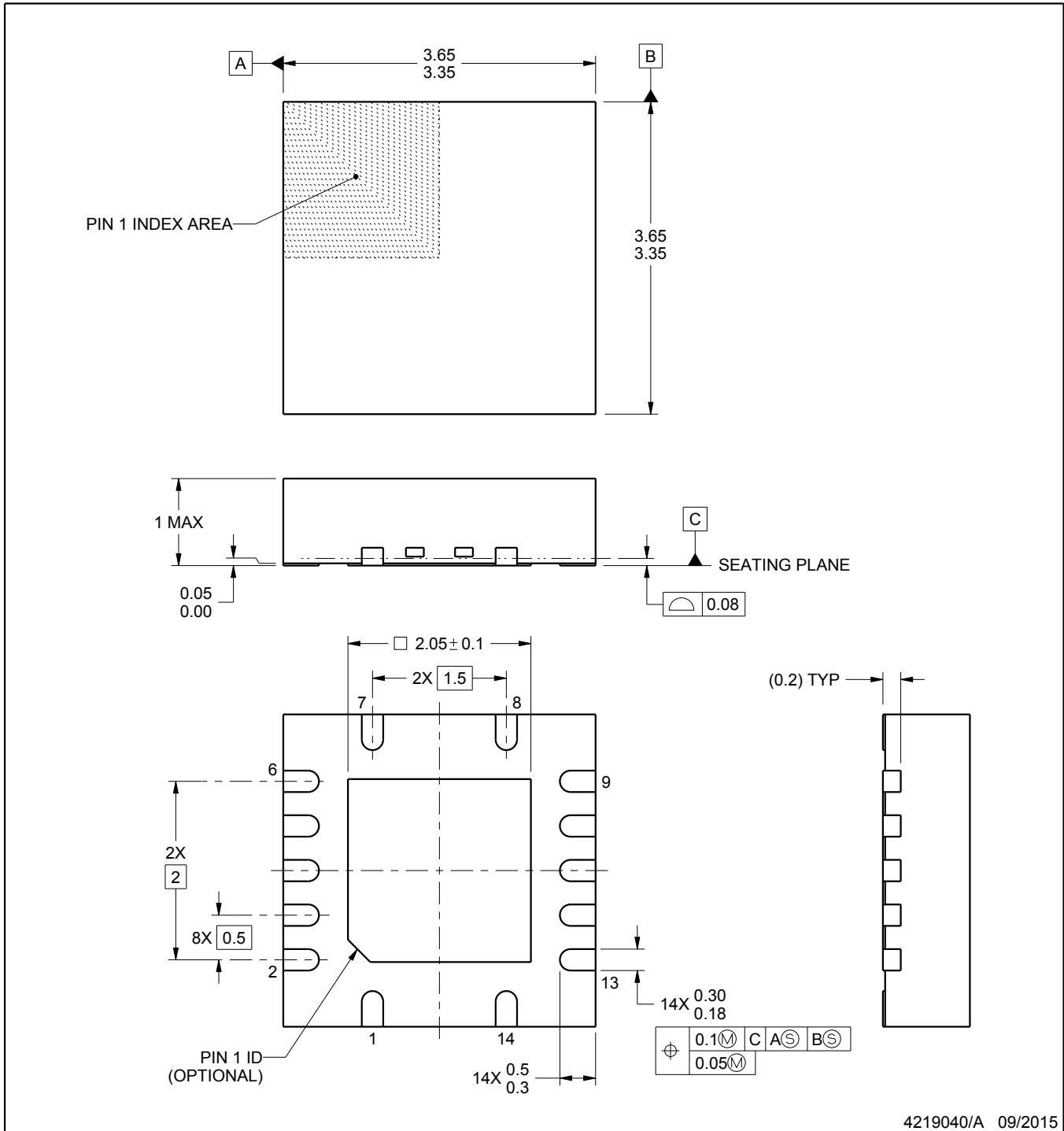
RGY0014A



PACKAGE OUTLINE

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



4219040/A 09/2015

NOTES:

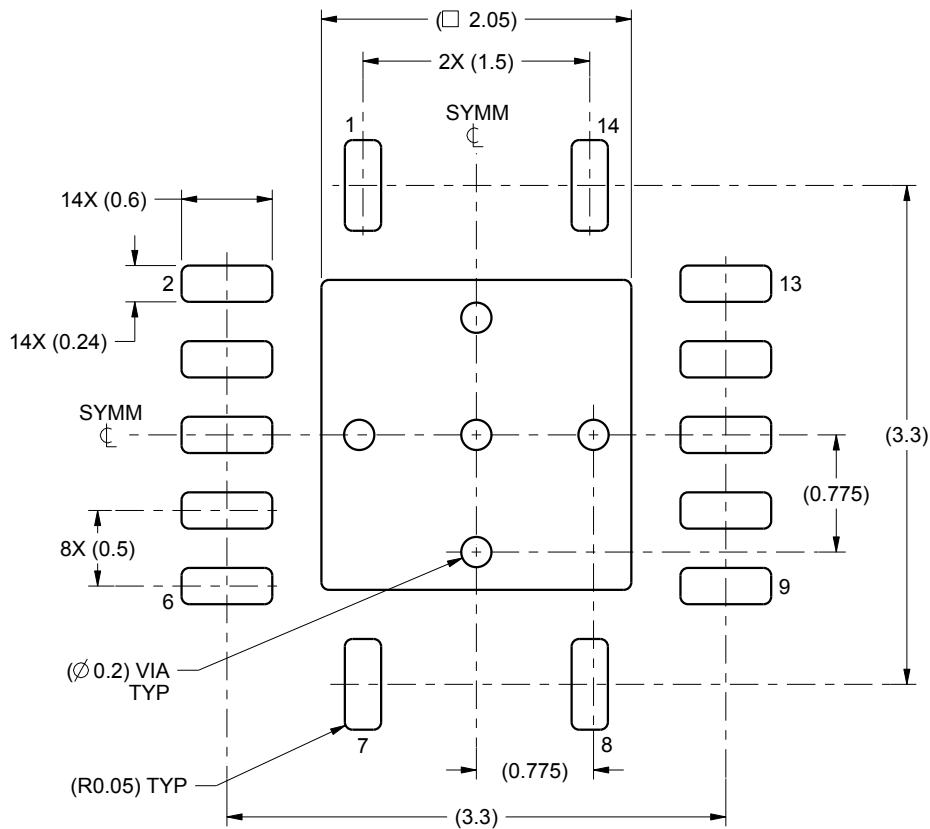
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

# EXAMPLE BOARD LAYOUT

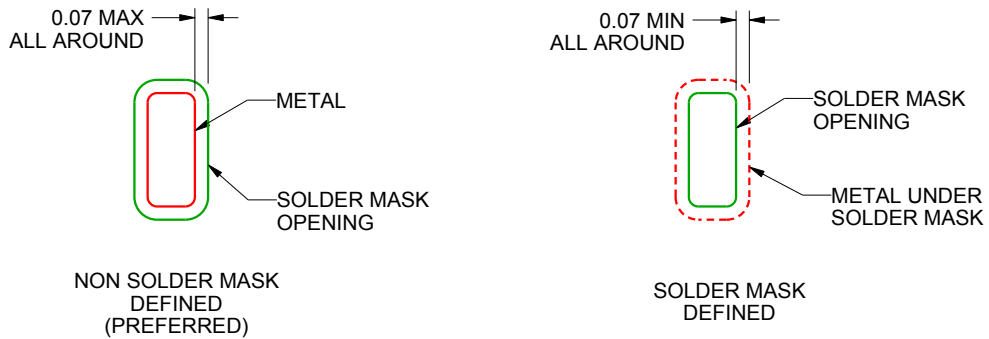
RGY0014A

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



LAND PATTERN EXAMPLE  
SCALE:20X



SOLDER MASK DETAILS

4219040/A 09/2015

NOTES: (continued)

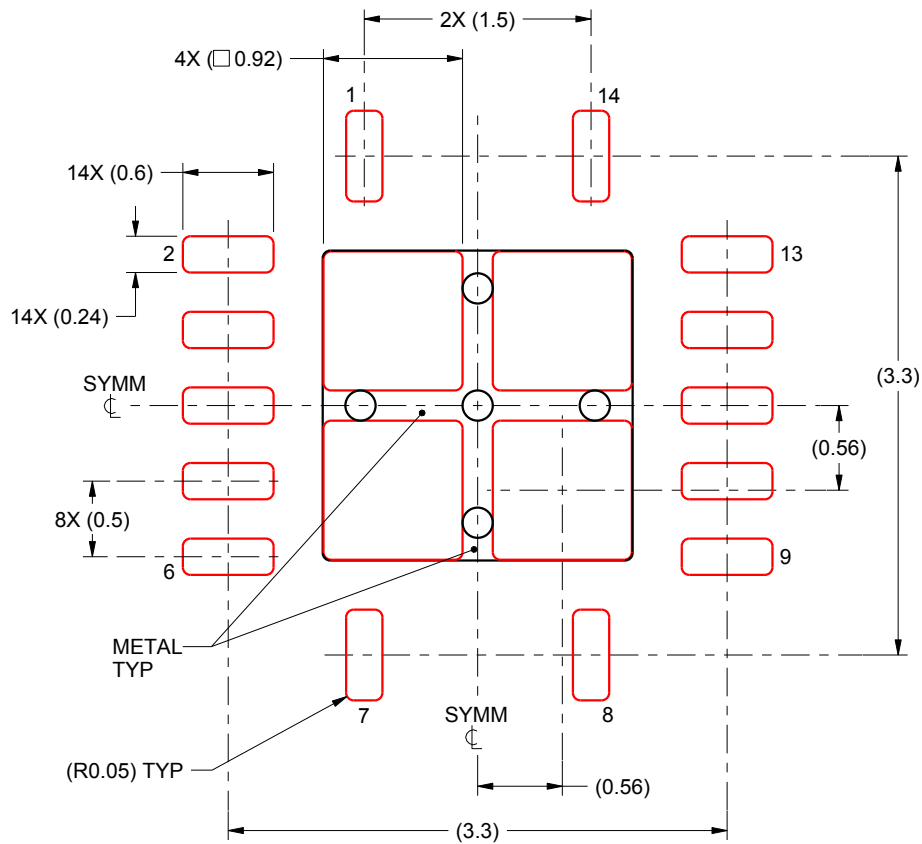
4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 ([www.ti.com/lit/slue271](http://www.ti.com/lit/slue271)).

# EXAMPLE STENCIL DESIGN

RGY0014A

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



**SOLDER PASTE EXAMPLE**  
BASED ON 0.125 mm THICK STENCIL

EXPOSED PAD  
80% PRINTED SOLDER COVERAGE BY AREA  
SCALE:20X

4219040/A 09/2015

NOTES: (continued)

5. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.



# D0014A

# PACKAGE OUTLINE

## SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



4220718/A 09/2016

### NOTES:

1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm, per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm, per side.
5. Reference JEDEC registration MS-012, variation AB.

# EXAMPLE BOARD LAYOUT

D0014A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



LAND PATTERN EXAMPLE  
SCALE:8X



SOLDER MASK DETAILS

4220718/A 09/2016

NOTES: (continued)

- 6. Publication IPC-7351 may have alternate designs.
- 7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

D0014A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:8X

4220718/A 09/2016

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

## GENERIC PACKAGE VIEW

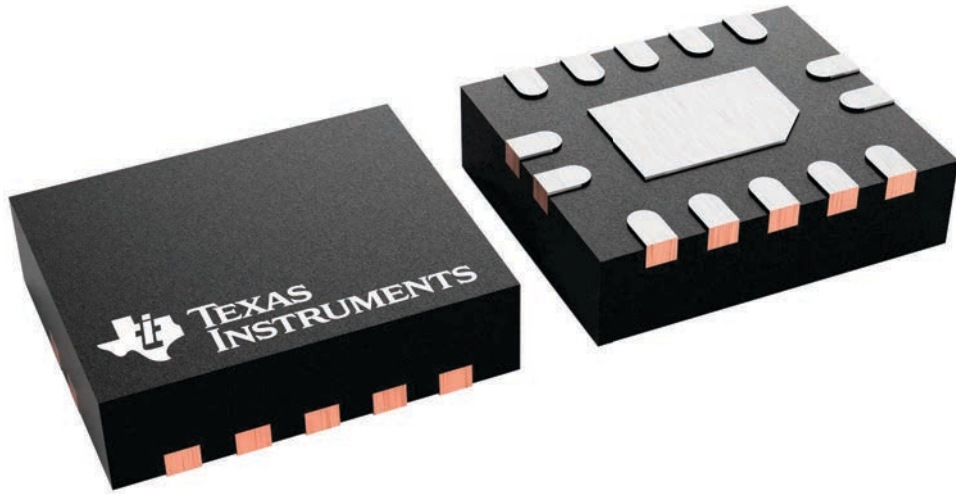
**BQA 14**

**WQFN - 0.8 mm max height**

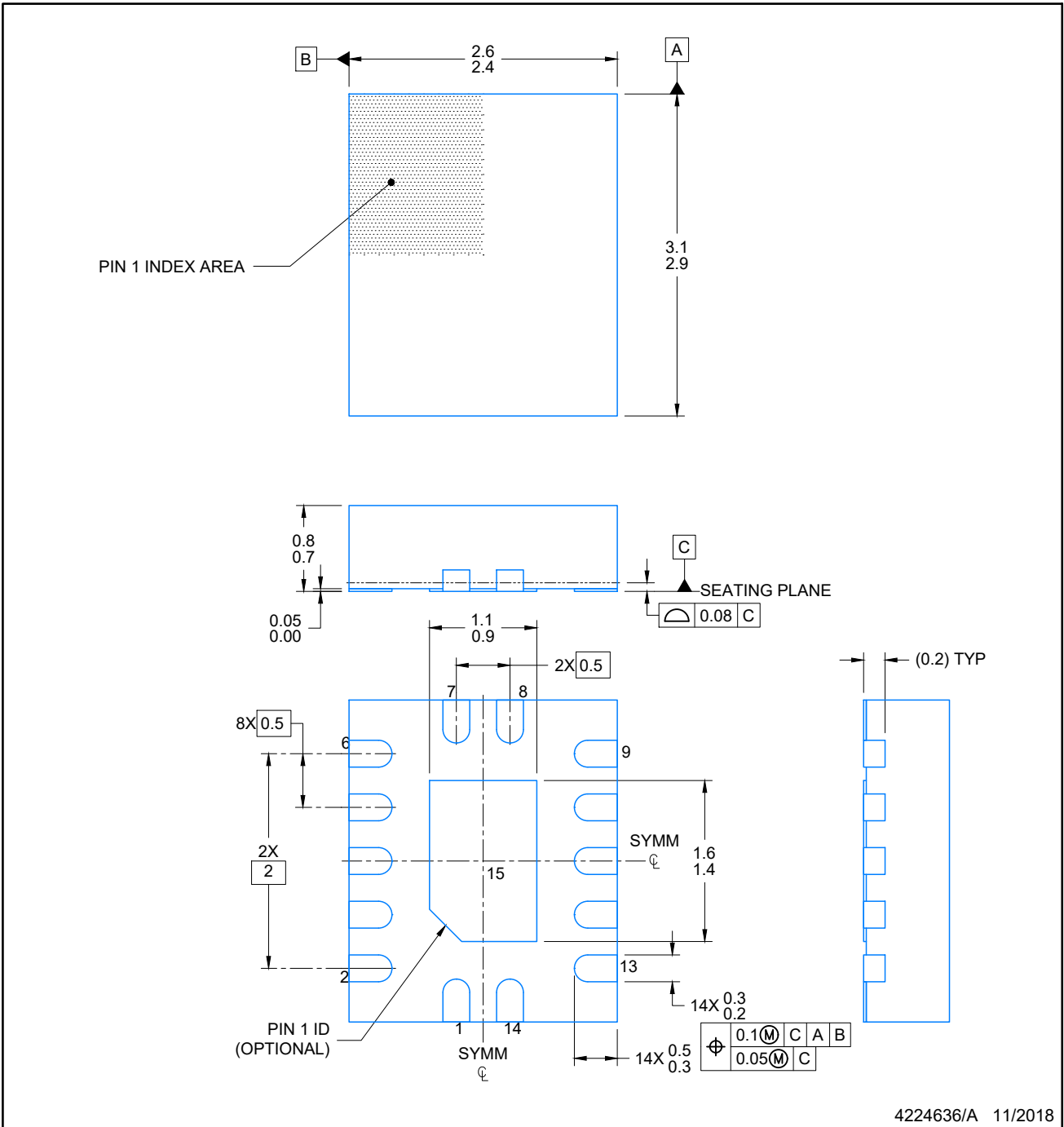
2.5 x 3, 0.5 mm pitch

PLASTIC QUAD FLATPACK - NO LEAD

This image is a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.



4227145/A



**NOTES:**

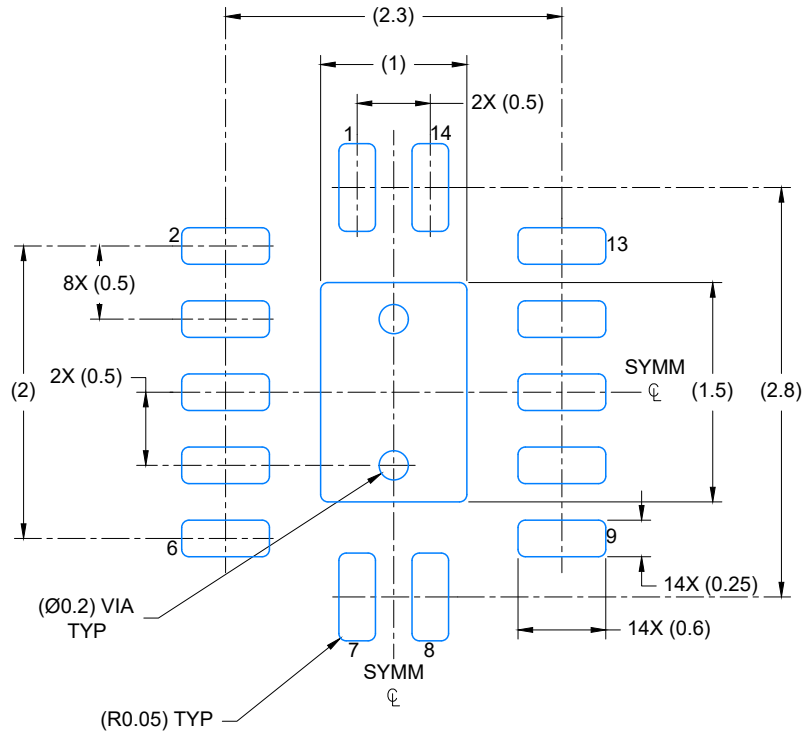
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for optimal thermal and mechanical performance.

# EXAMPLE BOARD LAYOUT

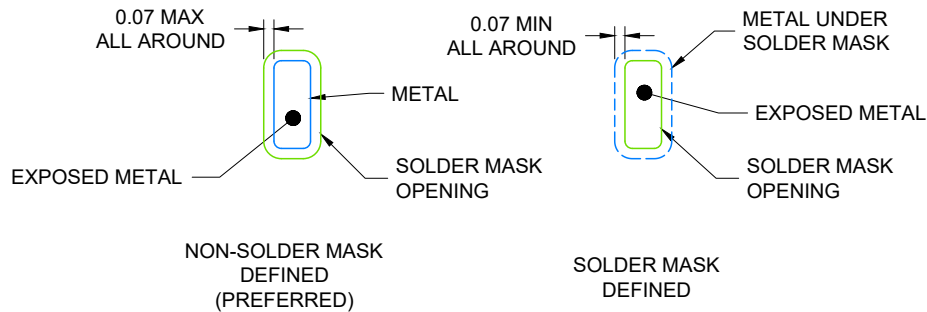
BQA0014A

WQFN - 0.8 mm max height

PLASTIC QUAD FLAT PACK-NO LEAD



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE: 20X



4224636/A 11/2018

NOTES: (continued)

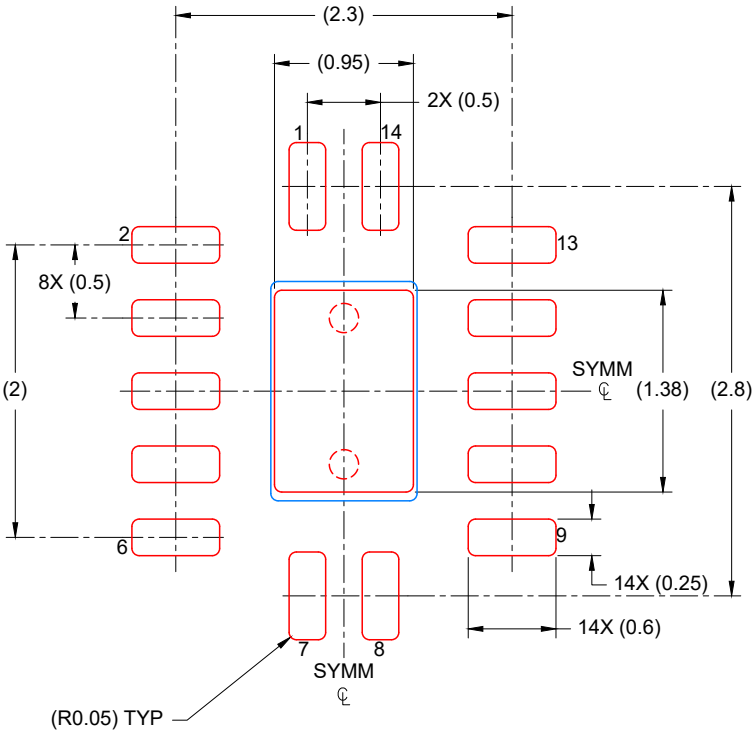
4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 ([www.ti.com/lit/slua271](http://www.ti.com/lit/slua271)).
5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.

# EXAMPLE STENCIL DESIGN

BQA0014A

WQFN - 0.8 mm max height

PLASTIC QUAD FLAT PACK-NO LEAD



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL

EXPOSED PAD  
88% PRINTED COVERAGE BY AREA  
SCALE: 20X

4224636/A 11/2018

NOTES: (continued)

- 6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

# MECHANICAL DATA

NS (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

## 重要なお知らせと免責事項

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